

NDIA 45th Annual Fuze Conference
Ordnance Fuzing/Safety & Arming
Programs Overview



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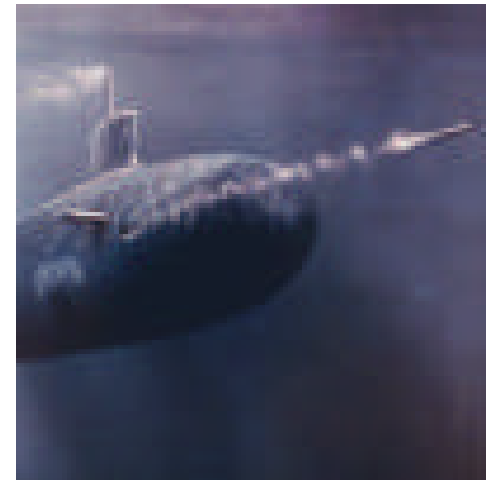
Report Documentation Page

Report Date 16Apr2001	Report Type N/A	Dates Covered (from... to) -
Title and Subtitle Ordnance Fuzing/Safety & Arming Programs Overview		Contract Number
		Grant Number
		Program Element Number
Author(s) Duong, Ann N.		Project Number
		Task Number
		Work Unit Number
Performing Organization Name(s) and Address(es) NSWC - Indian Head		Performing Organization Report Number
Sponsoring/Monitoring Agency Name(s) and Address(es) NDIA (National Defense Industrial Association) 211 Wilson BLvd., Ste. 400 Arlington, VA 22201-3061		Sponsor/Monitor's Acronym(s)
		Sponsor/Monitor's Report Number(s)
Distribution/Availability Statement Approved for public release, distribution unlimited		
Supplementary Notes Proceedings from The 45th Annual Fuze Conference, 16-18 April 2001 Sponsored by NDIA, The original document contains color images.		
Abstract		
Subject Terms		
Report Classification unclassified	Classification of this page unclassified	
Classification of Abstract unclassified	Limitation of Abstract UU	
Number of Pages 18		



OUTLINE

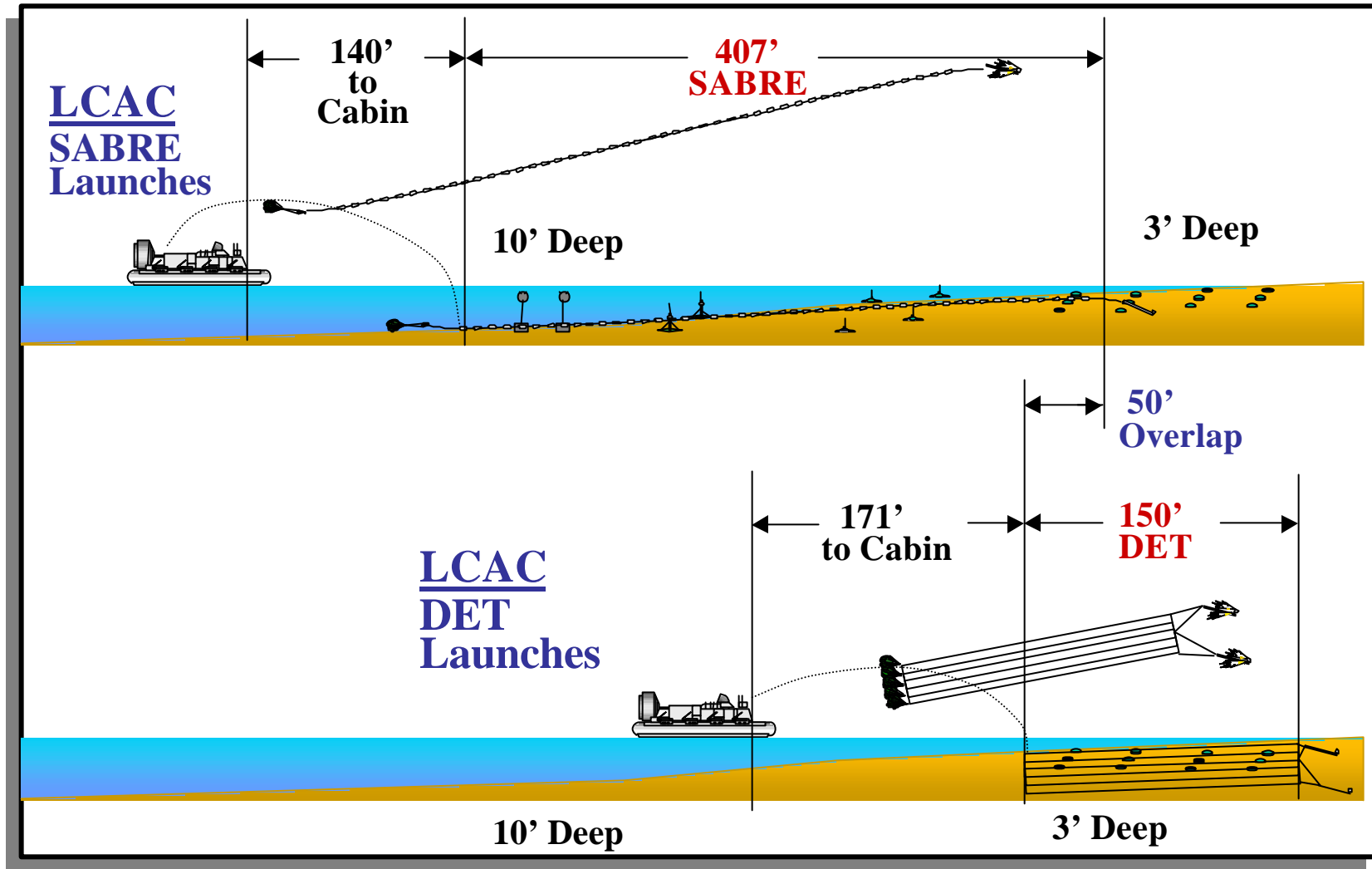
- ◆ **Current Development Programs**
- ◆ **Product Improvement Programs**
- ◆ **Applied MEMS Technology Programs**





Current Development Programs

Navy Assault Breaching Systems





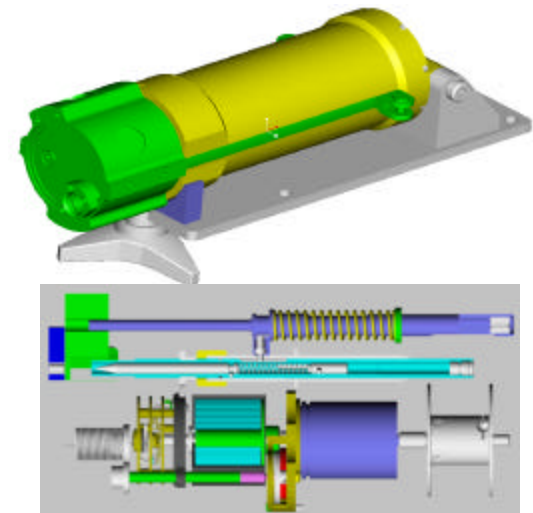
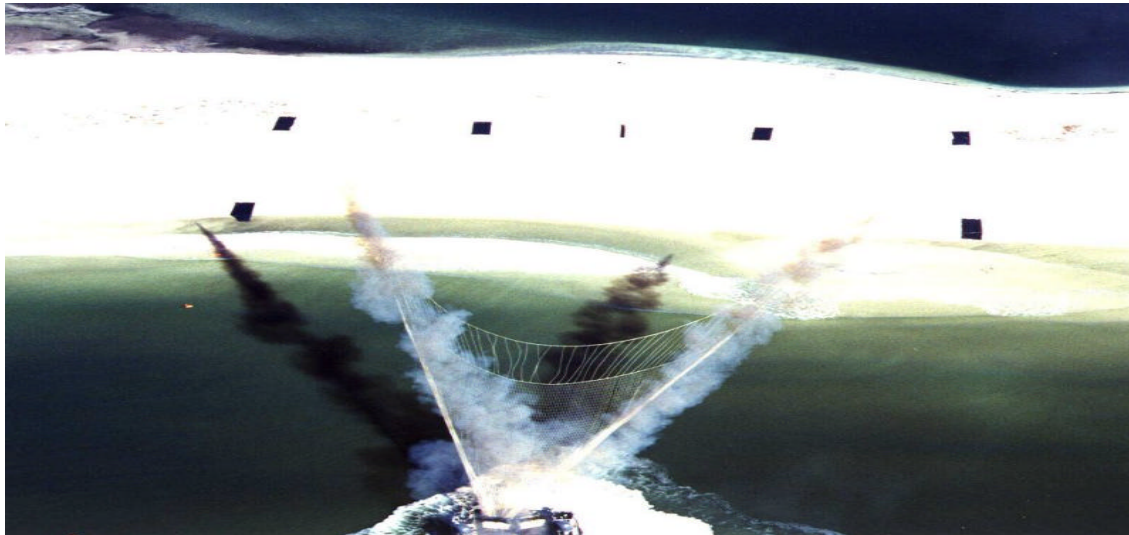
DET SURF ZONE MINE CLEARANCE SYSTEM TEST





DET Fuze/S&A

- ◆ **Distributed Explosive Technology (DET)**
 - 180'x180' Explosive Net Used in Surf Zone Mine Clearance
- ◆ **All Mechanical Fuze/Safety and Arming Device**
- ◆ **DET Technical Evaluation Completed**
- ◆ **DET Operational Evaluation Currently on Hold**
 - May be Combined with SABRE OPEVAL Scheduled FY03





SABRE Fuze/S&A

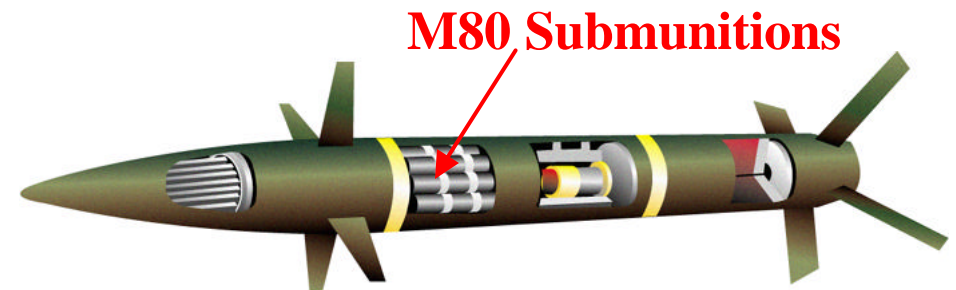
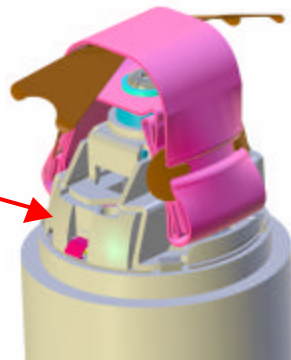
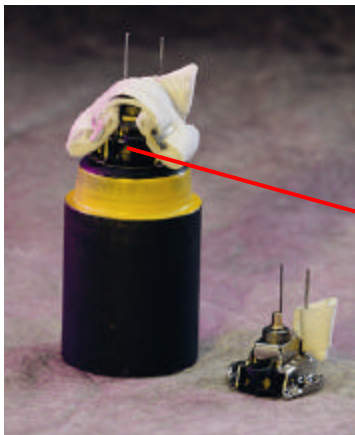
NEW START -- *New Fuze/S&A for Shallow-water Assault Breaching (SABRE) System*

- ◆ **Contractor Development - Contract Award in Process**
- ◆ **Fire-and-Forget Fuze/Safety and Arming System**
- ◆ **Requires Extremely High Reliability**
- ◆ **Support SABRE System MS III Production Decision of March 2003**



P3I Programs

◆ NSFS ERGM EX171 M80 Submunition PIP Proximity Fuze Insertion



◆ Next Generation Small Active Electromagnetic Torpedo Fuze



**EM Fuzed Torpedo
Shell Section**

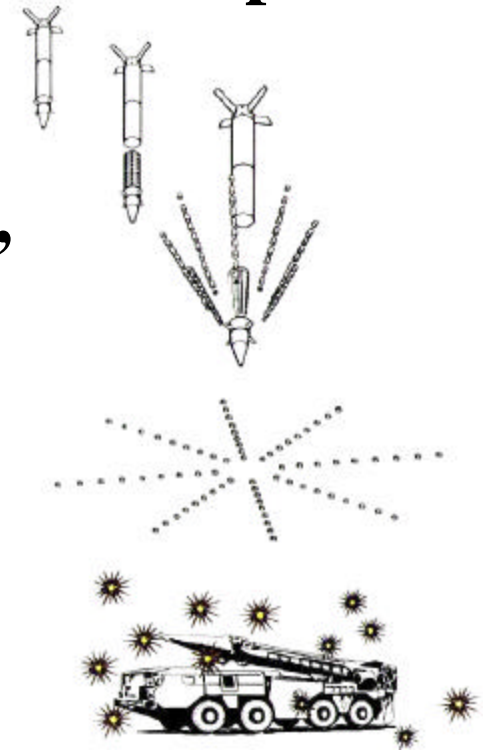


NSFS ERGM M80 Product Improvement Program (PIP)



PROGRAM GOALS:

- ◆ **Develop an Add-on Proximity Fuze System**
 - **Inserted within the M234 SD Fuze Envelope**
 - **Minimal Impact to M234 SD Fuze High Rate Production Equipment**
 - **Meet ERGM Safety, Performance, Environmental, & Life Cycle Requirements**



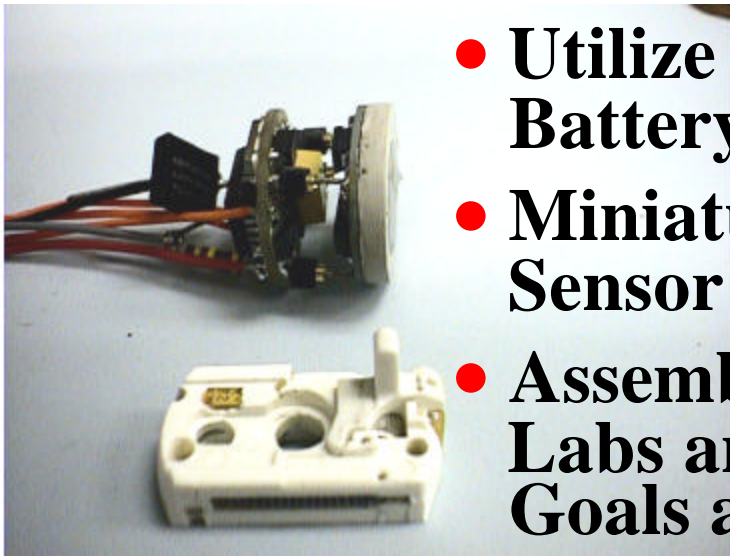


NSFS ERGM M80 PIP

Proximity Fuze System Insertion

TECHNICAL APPROACH:

◆ One-for-One Replacement of the M234 Self-Destruct (SD) Fuze Slide Assembly

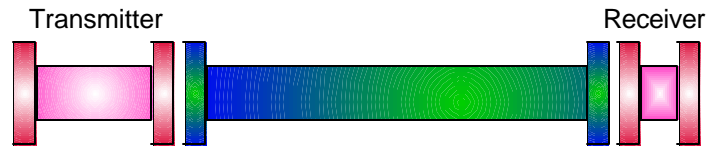
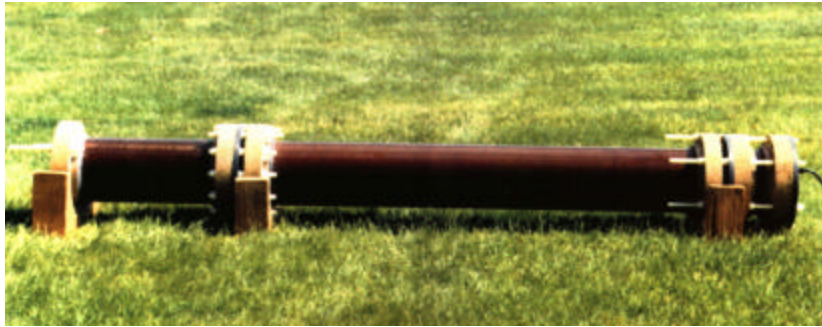


- Utilize Gun Launch Environment for Battery Activation
- Miniaturize the FM/CW RF Proximity Sensor of the M734A1 Mortar Fuze
- Assemble Expertise from Army / Navy Labs and Industry to Achieve Technical Goals and Reduce Critical Risk Areas





Reduced Power Active EM Fuze Underwater Torpedo Applications

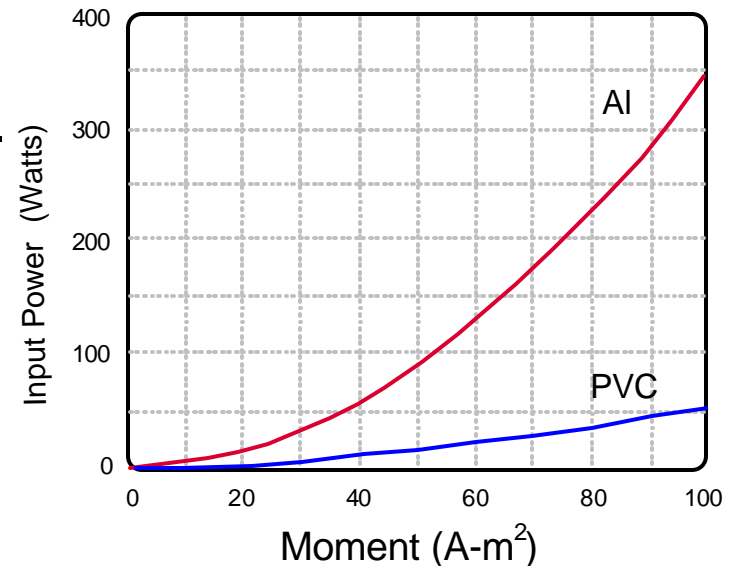
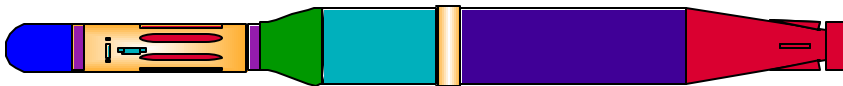


Proof-of-Principle Demonstrated

- 7:1 Reduction Input Power
- Multiple Transmitter Designs
- Suitability of EM Fuzing for Small Diameter torpedoes

Successful Torpedo Sea Run Tests

- Dynamic Environments
- Target Detection
- Model Validation

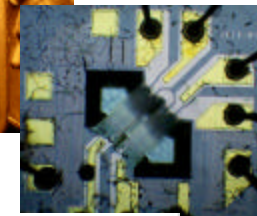
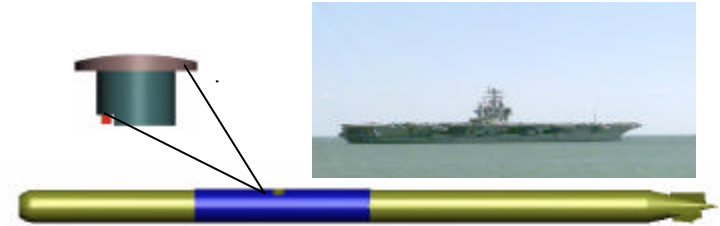




Applied MEMS Technology



- ◆ Surface Ship ATT F/S&A Device
- ◆ Standard Missile Embedded Sensors
- ◆ Ordnance Inventory & Surveillance





NAVY MEMS-BASED F/S&A PROGRAM



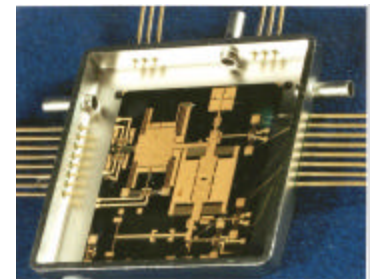
OBJECTIVE:

- ◆ **Apply & Transition MEMS Technology to Undersea Weapon F/S&A Systems**



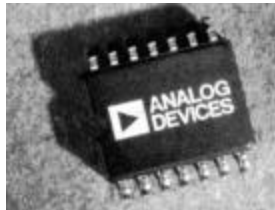
APPROACH:

- ◆ **Capitalize on the MEMS Industrial Base**
 - Commercial (COTS) Sensors & Devices
- ◆ **Leverage DARPA Funded Infrastructure**
 - Design, Modeling & Analyses Capability
- ◆ **Demonstrate MEMS F/S&A Reliability**
 - Assure Weapon Safety with Miniaturized Modular Architecture





MEMS F/S&A TECHNOLOGY COTS / Modular Components



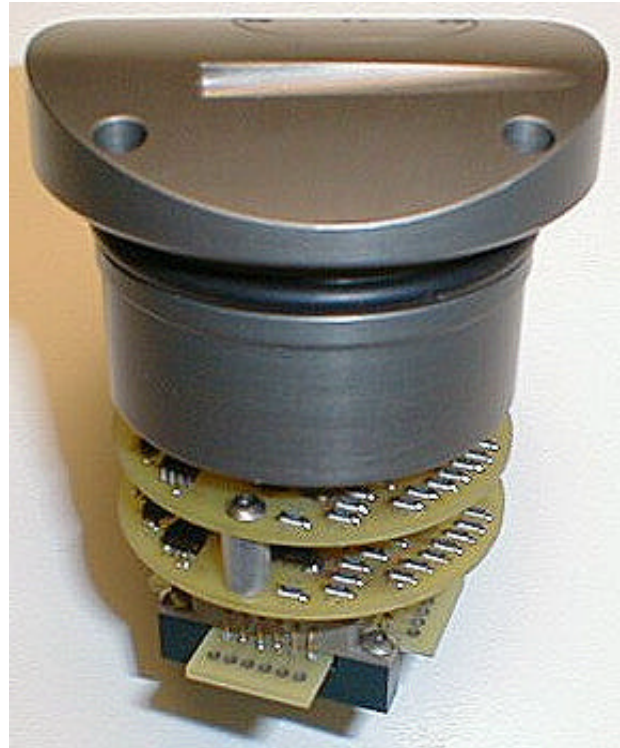
Impact Sensor



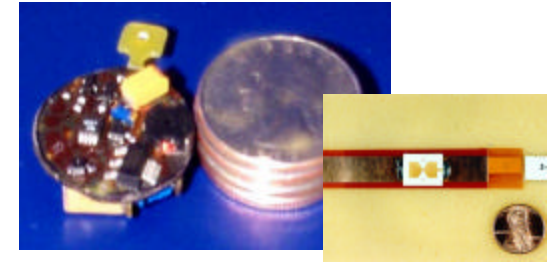
**Flow Sensor:
Pressure Differential**



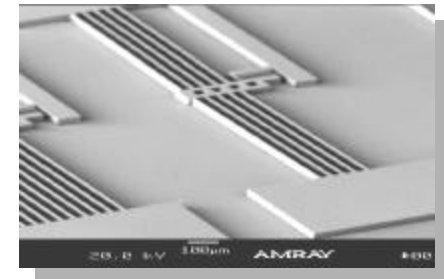
**Inertial Measurement
Rate Sensor**



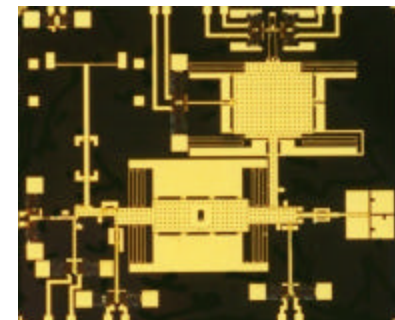
**Typical Building Block Components
for MEMS-Based Exploder**



**Initiation System
Slapper, Fire-set & Optical
Charging Circuit**



DRIE MEMS CHIP



LIGA S&A Chip



TORPEDO MEMS F/S&A



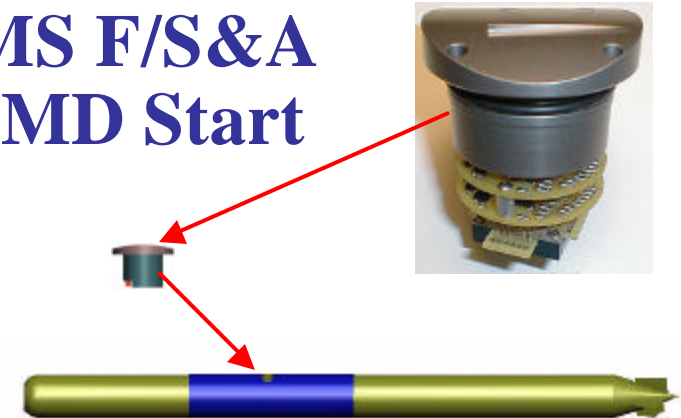
Main Objective: Transition MEMS F/S&A
Technology for FY 02 CCAT E&MD Start

Technology Focus:

- ◆ MEMS Fabrication
- ◆ Packaging Reliability and Robustness
- ◆ Inertial Sensor (IMU) Technology
- ◆ Remote Initiation Systems
- ◆ Optical Interruption

Prototype Development:

- ◆ Develop/Build 15 S&A Prototypes
- ◆ Conduct Environmental and Field T&E
- ◆ Utilize IHD MEMS Clean Room for MEMS S&A Prototypes Packaging, Assembly, & Test





Standard Missile

- ◆ Installing Temperature Data Loggers to Canisters
- ◆ Funded to Develop Embedded Stress Gauges
- ◆ Funded to Develop Embedded Ultrasonic Sensors





Advanced Technology Ordnance Surveillance (ATOS)



- Selected by OSD as an FY 01 Advanced Concept Technology Demonstration
- Demonstrate operational utility of miniature radio frequency identification (RFID) tags coupled with micro-electromechanical sensor (MEMs) technology for use in tracking/monitoring critical items:
 - Joint “high dollar/low density” munitions
 - Category I munitions (high potential of theft/terrorist use)
 - Future Potential: Medical and biological supplies, perishable substance and other environmentally sensitive commodities, DU munitions, etc.

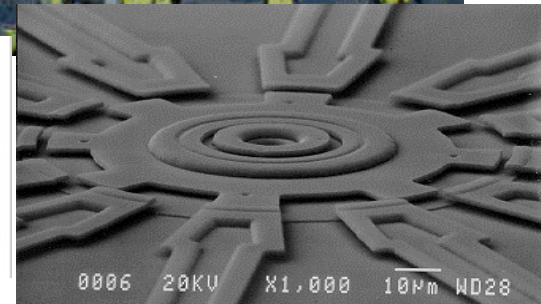
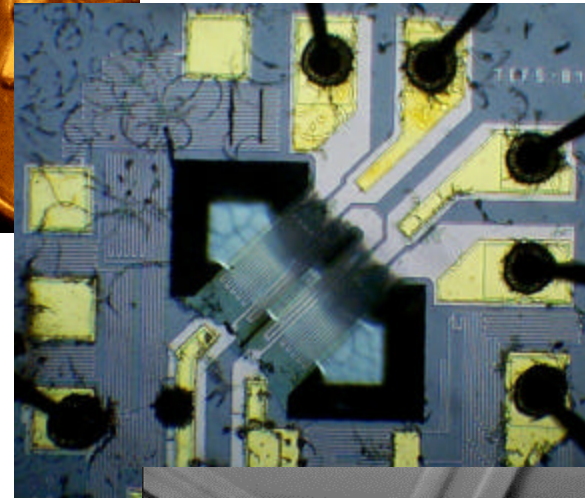
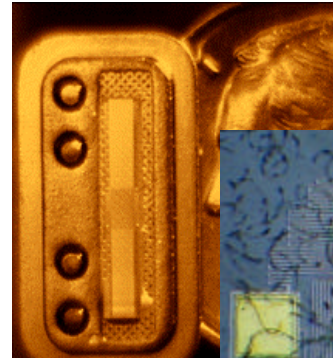




MEMS Sensors



- Temperature
- Humidity
- Stress/Strain
- Acceleration
 - Shock/Vibration History
- Chemistry Lab on a Chip
 - Presence of Degradation Products
 - Stabilizer Depletion

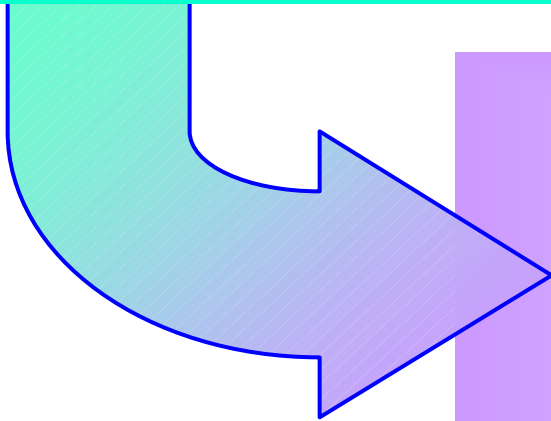




FUZE / SAFE & ARMING FOR THE 21ST Century

. Challenges / Opportunities

- Shrinking DOD budgets / downsizing
- Affordable weapon systems / reduced LCC
- Smarter, multipurpose weapon systems
- Acquisition reform
- Maintain critical smart F/S&A core within DOD
- Miniaturization



. Approach

- Focus on electronics & emerging MEMS technology in industry
- Increase joint service collaborative efforts
- Develop “building Block” approach for universal application